# **ESH1DFSH** Taiwan Semiconductor

# 1A, 200V Ultra Fast Surface Mount Rectifier

#### FEATURES

- AEC-Q101 qualified
- Glass passivated chip junction
- Ideal for automated placement
- Low profile package
- Ultra Fast recovery time for high efficiency
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

#### APPLICATIONS

- High frequency rectification
- Freewheeling application
- Switching mode converters and inverters in automotive

#### **MECHANICAL DATA**

- Case: SOD-128
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Mattle tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.027 g (approximately)

| KEY PARAMETERS     |            |      |  |
|--------------------|------------|------|--|
| PARAMETER          | VALUE      | UNIT |  |
| I <sub>F</sub>     | 1          | А    |  |
| V <sub>RRM</sub>   | 200        | V    |  |
| I <sub>FSM</sub>   | 60         | А    |  |
| T <sub>J MAX</sub> | 175        | °C   |  |
| Package            | SOD-128    |      |  |
| Configuration      | Single die |      |  |







| ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise noted) |           |                     |              |      |
|---|-----------|---------------------|--------------|------|
| PARAMETER   |           | SYMBOL              | ESH1DFSH     | UNIT |
| Marking code on the device  |           |                     | H1DFSH       |      |
| Repetitive peak reverse voltage   |           | V <sub>RRM</sub>    | 200          | V    |
| Reverse voltage, total rms value  |           | V <sub>R(RMS)</sub> | 140          | V    |
| Forward current   |           | I <sub>F</sub>      | 1            | А    |
| Surge peak forward current single half                                  | t = 8.3ms | I <sub>FSM</sub>    | 60           | А    |
| sine-wave superimposed on rated load                                    | t = 1.0ms |                     | 80           | А    |
| Junction temperature  |           | TJ                  | - 55 to +175 | °C   |
| Storage temperature   |           | T <sub>STG</sub>    | - 55 to +175 | °C   |







| THERMAL PERFORMANCE                    |                  |     |      |
|--|------------------|-----|------|
| PARAMETER                              | SYMBOL           | ТҮР | UNIT |
| Junction-to-lead thermal resistance    | R <sub>ejl</sub> | 18  | °C/W |
| Junction-to-ambient thermal resistance | R <sub>ejA</sub> | 72  | °C/W |
| Junction-to-case thermal resistance    | R <sub>eJC</sub> | 14  | °C/W |

Thermal Performance Note: Units mounted on PCB (5mm x 5mm Cu pad test board)

| <b>ELECTRICAL SPECIFICATIONS</b> ( $T_A = 25^{\circ}C$ unless otherwise noted) |  |                  |      |      |      |
|--|--|------------------|------|------|------|
| PARAMETER  | CONDITIONS                                   | SYMBOL           | ТҮР  | MAX  | UNIT |
| Forward voltage <sup>(1)</sup>   | $I_F = 0.5A, T_J = 25^{\circ}C$              | V <sub>F</sub>   | 0.80 | -    | V    |
|  | $I_F = 1.0A, T_J = 25^{\circ}C$              |                  | 0.84 | 0.94 | V    |
|  | $I_F = 0.5A, T_J = 125^{\circ}C$             |                  | 0.64 | -    | V    |
|  | $I_F = 1.0A, T_J = 125^{\circ}C$             |                  | 0.71 | 0.81 | V    |
| Reverse current @ rated V <sub>R</sub> <sup>(2)</sup>                          | T <sub>J</sub> = 25°C                        | - I <sub>R</sub> | -    | 5    | μA   |
|  | T <sub>J</sub> = 125°C                       |                  | -    | 27   | μA   |
| Junction capacitance   | 1MHz, V <sub>R</sub> = 4.0V                  | CJ               | 15   | -    | pF   |
| Reverse recovery time  | $I_F = 0.5A, I_R = 1.0A$<br>$I_{rr} = 0.25A$ | t <sub>rr</sub>  | -    | 25   | ns   |

#### Notes:

1. Pulse test with PW = 0.3ms

2. Pulse test with PW = 30ms

| ORDERING INFORMATION |         |                      |
|----------------------|---------|----------------------|
| ORDERING CODE        | PACKAGE | PACKING              |
| ESH1DFSH             | SOD-128 | 14,000 / Tape & Reel |



## **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

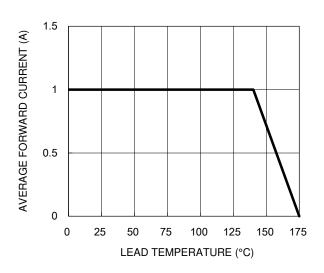
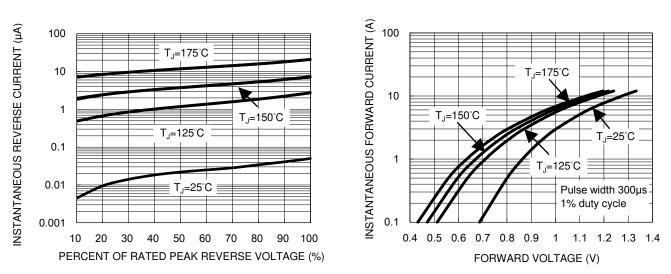
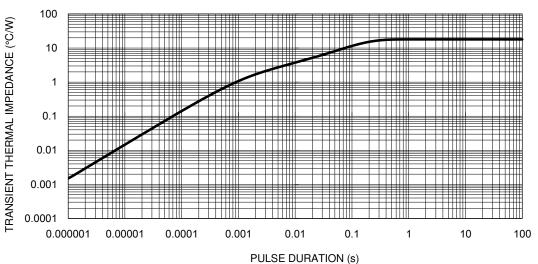


Fig.1 Forward Current Derating Curve

#### **Fig.3 Typical Reverse Characteristics**





### Fig.5 Typical Transient Thermal Impedance

Fig.2 Typical Junction Capacitance

10

REVERSE VOLTAGE (V)

**Fig.4 Typical Forward Characteristics** 

100

100

10

1

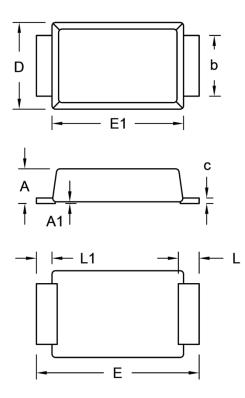
1

f=1.0MHz Vsig=50mVp-p

CAPACITANCE (pF)

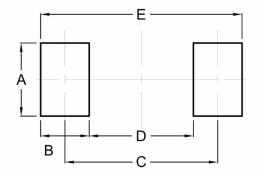


SOD-128



| DIM. | Unit |      | Unit  | nit (inch) |  |
|------|------|------|-------|------------|--|
|      | Min. | Max. | Min.  | Max.       |  |
| A    | 0.90 | 1.10 | 0.035 | 0.043      |  |
| A1   | 0.00 | 0.10 | 0.000 | 0.004      |  |
| b    | 1.60 | 1.90 | 0.063 | 0.075      |  |
| с    | 0.10 | 0.22 | 0.004 | 0.009      |  |
| D    | 2.30 | 2.70 | 0.091 | 0.106      |  |
| E    | 4.40 | 5.00 | 0.173 | 0.197      |  |
| E1   | 3.60 | 4.00 | 0.142 | 0.157      |  |
| L    | 0.40 | 0.80 | 0.016 | 0.031      |  |
| L1   | 0.30 | 0.60 | 0.012 | 0.024      |  |

#### SUGGESTED PAD LAYOUT



| Symbol | Unit (mm) | Unit (inch) |
|--------|-----------|-------------|
| A      | 2.10      | 0.083       |
| В      | 1.40      | 0.055       |
| С      | 4.40      | 0.173       |
| D      | 3.00      | 0.118       |
| E      | 5.80      | 0.228       |

## **MARKING DIAGRAM**



| P/N | = Marking Code |
|-----|----------------|
| YW  | = Date Code    |
| F   | = Factory Code |



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